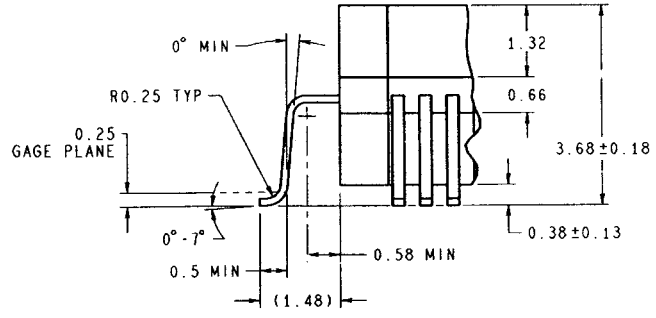
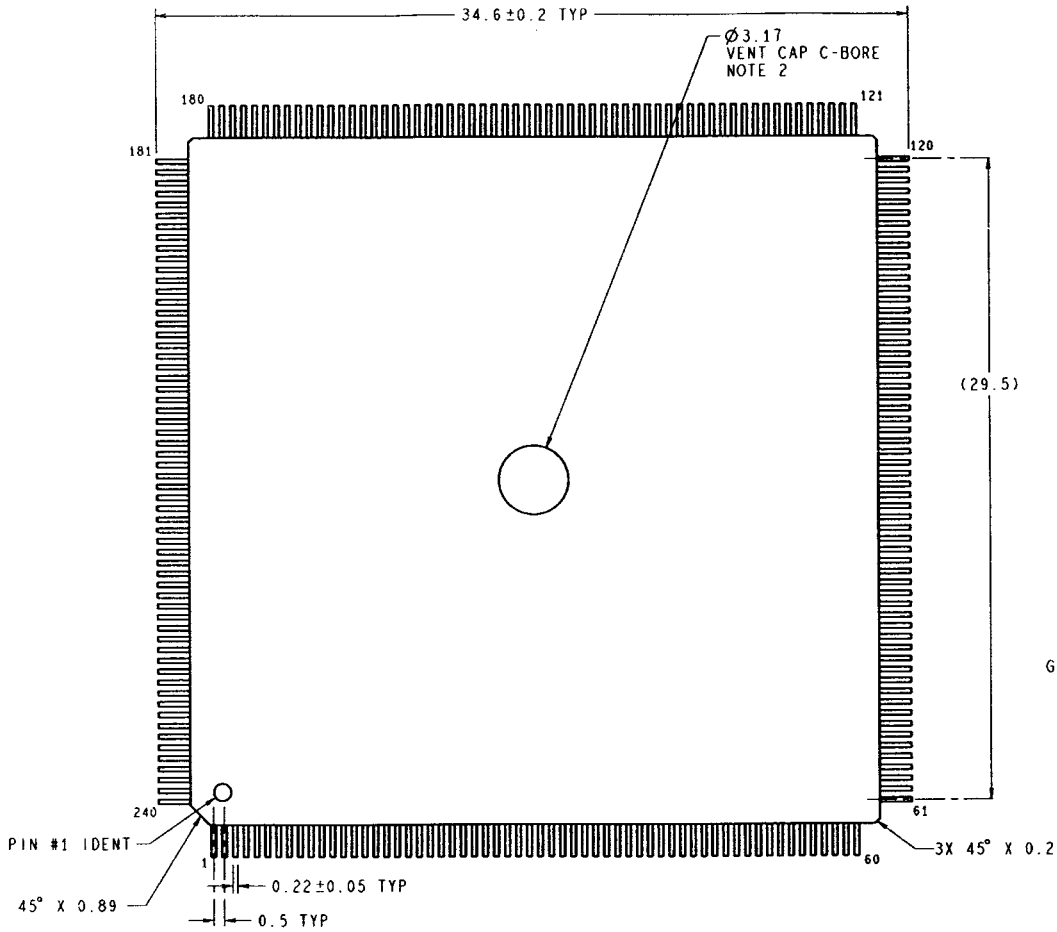
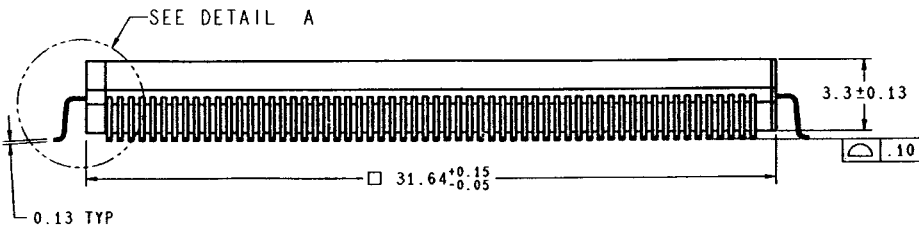


REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
B	REVISE AND REDRAW PER NEW STANDARD	11184	10/30/95	DEG/SM



DETAIL A  
TYP. SCALE: 15X  
NOTE 2



DIMENSIONS ARE IN MILLIMETERS

- NOTES: UNLESS OTHERWISE SPECIFIED.
- STANDARD LEAD FINISH: 5.08 MICROMETERS MINIMUM SOLDER PLATING (85/15) THICKNESS.
  - THE LEADS CAN BE FORMED FOR CAVITY UP OR DOWN:  
-THE VENT CAP WILL BE ON THE TOP FOR CAVITY UP (SHOWN)  
-THE VENT CAP WILL BE ON THE BOTTOM FOR CAVITY DOWN
  - REFERENCE: OLIN DRAWING 04-240-YH-001, REV D, DATED MAY/93

APPROVALS		DATE		National Semiconductor 2900 Semiconductor dr. Santa Clara, CA 95052-0090	
DRAWN <i>D.E. Grady</i>	DATE 10/30/95	DFTG. CHR. <i>[Signature]</i>	DATE 1/19/96		
ENGR. CHR. <i>[Signature]</i>		DATE 06/11/96		<b>MQUAD,</b> <b>32 X 32 X 3.3mm,</b> <b>240 LEAD</b>	
		SCALE	SIZE	DRAWING NUMBER	REV
		N/A	C	MKT-AWA240A	B
DO NOT SCALE DRAWING				SHEET 1 of 1	